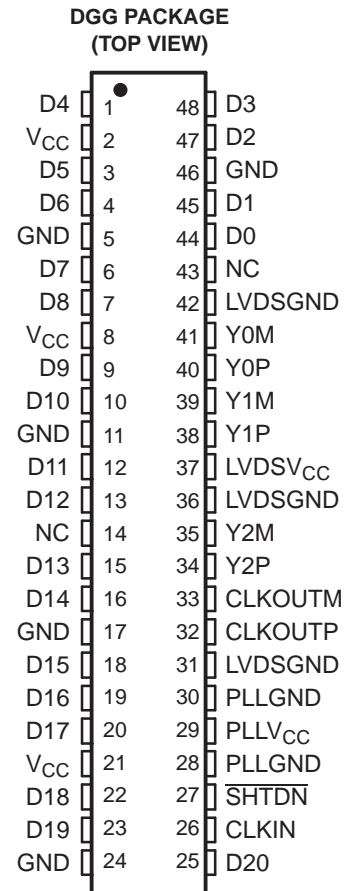


## FlatLink™ TRANSMITTER

### FEATURES

- **21:3 Data Channel Compression at up to 196 Mbytes/s Throughput**
- **Suited for SVGA, XGA, or SXGA Data Transmission From Controller to Display With Very Low EMI**
- **21 Data Channels Plus Clock In Low-Voltage TTL Inputs and 3 Data Channels Plus Clock Out Low-Voltage Differential Signaling (LVDS) Outputs**
- **Operates From a Single 3.3-V Supply and 89 mW (Typ)**
- **Packaged in Thin Shrink Small-Outline Package (TSSOP) With 20-Mil Terminal Pitch**
- **Consumes Less Than 0.54 mW When Disabled**
- **Wide Phase-Lock Input Frequency Range: 31 MHz to 75 MHz**
- **No External Components Required for PLL**
- **Outputs Meet or Exceed the Requirements of ANSI EIA/TIA-644 Standard**
- **SSC Tracking Capability of 3% Center Spread at 50-kHz Modulation Frequency**
- **Improved Replacement for SN75LVDS84 and NSC DS90CF363A 3-V Device**
- **Qualified for Automotive Applications**



NC – Not Connected

### DESCRIPTION/ORDERING INFORMATION

The SN65LVDS84AQ FlatLink™ transmitter contains three 7-bit parallel-load serial-out shift registers, and four low-voltage differential signaling (LVDS) line drivers in a single integrated circuit. These functions allow 21 bits of single-ended LVTTTL data to be synchronously transmitted over 3 balanced-pair conductors for receipt by a compatible receiver, such as the SN75LVDS82 or SN75LVDS86/86A.

When transmitting, data bits D0–D20 are each loaded into registers of the SN65LVDS84AQ upon the falling edge. The internal PLL is frequency-locked to CLKIN and then used to unload the data registers in 7-bit slices. The three serial streams and a phase-locked clock (CLKOUT) are then output to LVDS output drivers. The frequency of CLKOUT is the same as the input clock, CLKIN.

The SN65LVDS84AQ requires no external components and little or no control. The data bus appears the same at the input to the transmitter and output of the receiver with the data transmission transparent to the user(s). The only user intervention is the possible use of the shutdown/clear (SHTDN) active-low input to inhibit the clock and shut off the LVDS output drivers for lower power consumption. A low-level on this signal clears all internal registers to a low level.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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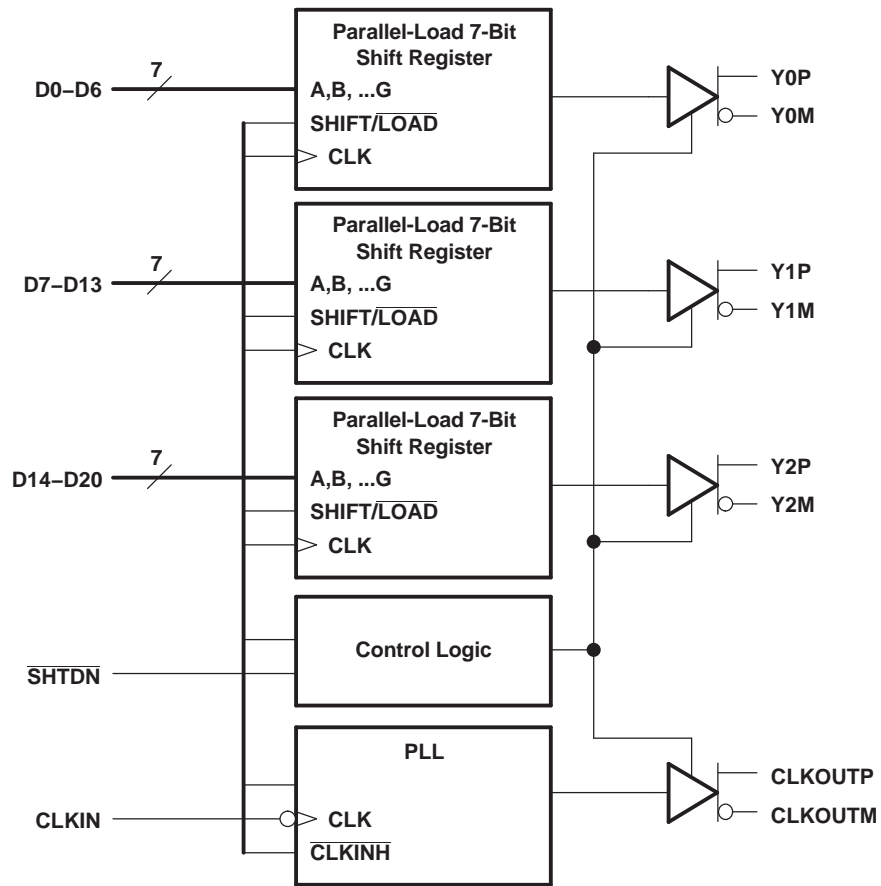
The SN65LVDS84AQ is characterized for operation over the full automotive temperature range of  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ .

**ORDERING INFORMATION<sup>(1)</sup>**

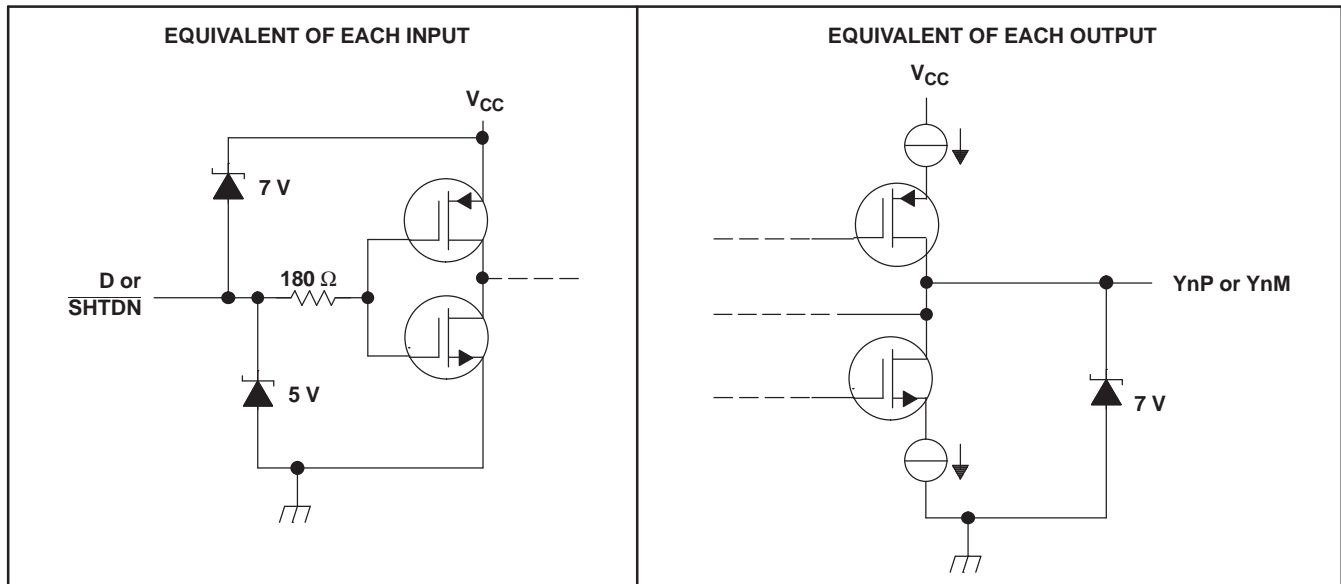
T <sub>A</sub>	PACKAGE <sup>(2)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
$-40^{\circ}\text{C}$ to $125^{\circ}\text{C}$	TSSOP – DGG	Reel of 2000	SN65LVDS84ADGGRQ1	65LVDS84AQ

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).

**FUNCTIONAL BLOCK DIAGRAM**



SCHEMATICS OF INPUT AND OUTPUT



**Absolute Maximum Ratings**<sup>(1)(2)</sup>

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range	-0.5	4	V
V <sub>O</sub> V <sub>I</sub>	Input and output voltage range (all terminals)	-0.5	V <sub>CC</sub> + 0.5	V
	Continuous total power dissipation	See Dissipation Rating Table		
T <sub>J</sub>	Operating virtual junction temperature range	-40	150	°C
ESD	Electrostatic discharge rating	Machine model	200	V
		Human-body model	6000	V
		Charged-device model	1500	V
T <sub>stg</sub>	Storage temperature range	-65	150	°C
	Lead temperature 1,6 mm (1/16 in) from case for 10 s		260	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to the GND terminals.

**Dissipation Rating Table**

PACKAGE	T <sub>A</sub> ≤ 25°C POWER RATING	DERATING FACTOR <sup>(1)</sup> ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 125°C POWER RATING
DGG	1637 mW	13.1 mW/°C	1048 mW	327 mW

- (1) This is the inverse of the junction-to-ambient thermal resistance when board mounted and with no air flow.

## Recommended Operating Conditions

		MIN	NOM	MAX	UNIT
$V_{CC}$	Supply voltage	3	3.3	3.6	V
$V_{IH}$	High-level input voltage	2			V
$V_{IL}$	Low-level input voltage			0.8	V
$Z_L$	Differential load impedance	90		132	$\Omega$
$T_A$	Operating free-air temperature	–40		125	$^{\circ}\text{C}$

## Timing Requirements

		MIN	NOM	MAX	UNIT
$t_c$	Input clock period	13.3	$t_c$	32.4	ns
$t_w$	Pulse duration, high-level input clock	0.4 $t_c$		0.6 $t_c$	ns
$t_t$	Transition time, input signal			5	ns
$t_{su}$	Setup time, data, D0–D20 valid before CLKIN $\downarrow$ (see Figure 2)	3			ns
$t_h$	Hold time, data, D0–D20 valid after CLKIN $\downarrow$ (see Figure 2)	1.5			ns

## Electrical Characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP <sup>(1)</sup>	MAX	UNIT	
$V_{IT}$	Input threshold voltage		1.4		V	
$ V_{OD} $	Differential steady-state output voltage magnitude	$R_L = 100 \Omega$ , See Figure 3		454	mV	
$\Delta V_{OD} $	Change in the steady-state differential output voltage magnitude between opposite binary states			50	mV	
$V_{OC(SS)}$	Steady-state common-mode output voltage	$R_L = 100 \Omega$ , See Figure 3	1.125	1.375	V	
$V_{OC(PP)}$	Peak-to-peak common-mode output voltage		80	150	mV	
$I_{IH}$	High-level input current	$V_{IH} = V_{CC}$		25	$\mu\text{A}$	
$I_{IL}$	Low-level input current	$V_{IL} = 0$		$\pm 10$	$\mu\text{A}$	
$I_{OS}$	Short-circuit output current	$V_{O(Yn)} = 0$		–6	$\pm 24$	mA
		$V_{OD} = 0$		–6	$\pm 12$	
$I_{OZ}$	High-impedance output current	$V_O = 0$ to $V_{CC}$		$\pm 10$	$\mu\text{A}$	
$I_{CC(AVG)}$	Quiescent supply current (average)	Disabled, All inputs at GND		15	170	mA
		Enabled, $R_L = 100 \Omega$ (4 places), Gray-scale pattern (see Figure 4)	$f = 65 \text{ MHz}$	27	35	
			$f = 75 \text{ MHz}$	30	38	
		Enabled, $R_L = 100 \Omega$ (4 places), Worst-case pattern (see Figure 5)	$f = 65 \text{ MHz}$	28	36	
$f = 75 \text{ MHz}$	31		39			
$C_i$	Input capacitance		2		pF	

(1) All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

## Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP <sup>(1)</sup>	MAX	UNIT
$t_{d0}$	Delay time, CLKOUT $\uparrow$ to serial bit position 0	-0.2		0.2	ns
$t_{d1}$	Delay time, CLKOUT $\uparrow$ to serial bit position 1	$\frac{1}{7}t_c - 0.2$		$\frac{1}{7}t_c + 0.2$	
$t_{d2}$	Delay time, CLKOUT $\uparrow$ to serial bit position 2	$\frac{2}{7}t_c - 0.2$		$\frac{2}{7}t_c + 0.2$	
$t_{d3}$	Delay time, CLKOUT $\uparrow$ to serial bit position 3	$\frac{3}{7}t_c - 0.2$		$\frac{3}{7}t_c + 0.2$	
$t_{d4}$	Delay time, CLKOUT $\uparrow$ to serial bit position 4	$\frac{4}{7}t_c - 0.2$		$\frac{4}{7}t_c + 0.2$	
$t_{d5}$	Delay time, CLKOUT $\uparrow$ to serial bit position 5	$\frac{5}{7}t_c - 0.2$		$\frac{5}{7}t_c + 0.2$	
$t_{d6}$	Delay time, CLKOUT $\uparrow$ to serial bit position 6	$\frac{6}{7}t_c - 0.2$		$\frac{6}{7}t_c + 0.2$	
$t_{sk(o)}$	Output skew, $t_n - \frac{n}{7}t_c$	-0.2		0.2	ns
$t_{d7}$	Delay time, CLKIN $\downarrow$ to CLKOUT $\uparrow$	$t_c = 15.38 \text{ ns } (\pm 0.2\%),$  Input clock jitter  < 50 ps <sup>(2)</sup> , See <a href="#">Figure 6</a>		2.7	ns
		$t_c = 13.33 \text{ ns } \sim 32.25 \text{ ns } (\pm 0.2\%),$  Input clock jitter  < 50 ps <sup>(2)</sup> , See <a href="#">Figure 6</a>	1	4.5	
$\Delta t_{c(o)}$	Cycle time, output clock jitter <sup>(3)</sup>	$t_c = 15.38 + 0.308 \sin(2\pi 500E3t) \pm 0.05 \text{ ns},$ See <a href="#">Figure 7</a>		$\pm 62$	ps
		$t_c = 15.38 + 0.308 \sin(2\pi 3E6t) \pm 0.05 \text{ ns},$ See <a href="#">Figure 7</a>		$\pm 121$	
$t_w$	Pulse duration, high-level output clock		$\frac{4}{7}t_c$		ns
$t_t$	Transition time, differential output voltage ( $t_r$ or $t_f$ )	See <a href="#">Figure 3</a>	700	1500	ps
$t_{en}$	Enable time, $\overline{\text{SHTDN}}\uparrow$ to phase lock (Yn valid)	See <a href="#">Figure 8</a>	1		ms
$t_{dis}$	Disable time, $\overline{\text{SHTDN}}\downarrow$ to off state (CLKOUT low)	See <a href="#">Figure 9</a>	6.5		ns

 (1) All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

(2) |Input clock jitter| is the magnitude of the change in the input clock period.

(3) Output clock jitter is the change in the output clock period from one cycle to the next cycle observed over 15000 cycles.

PARAMETER MEASUREMENT INFORMATION

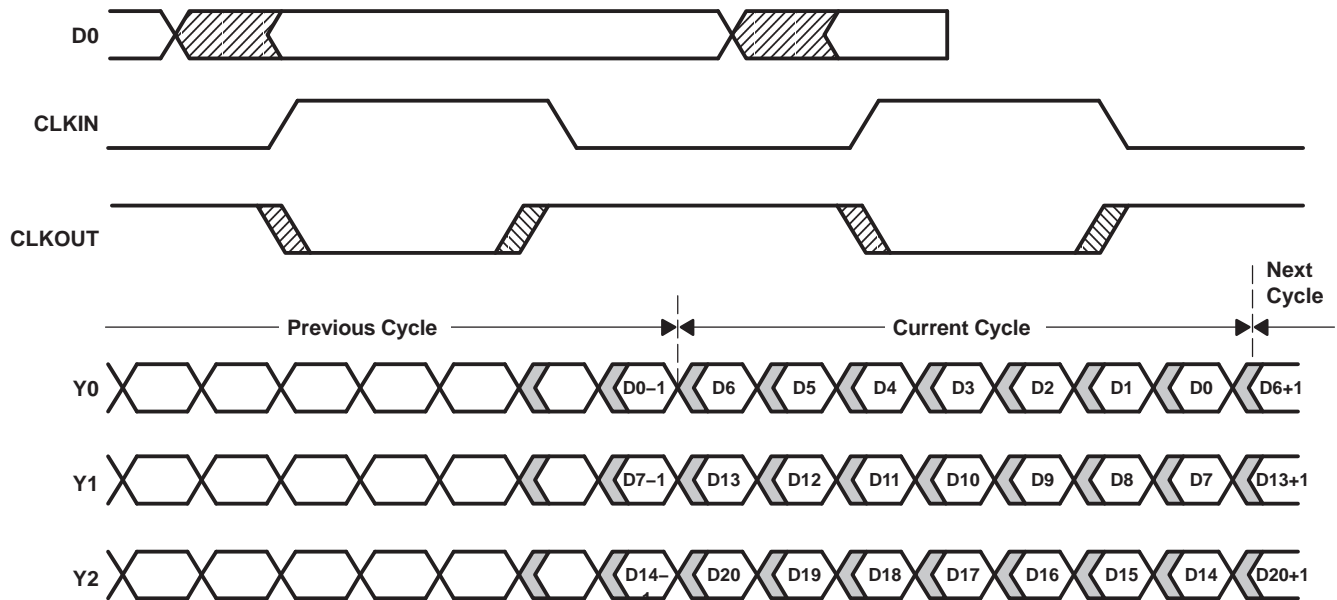
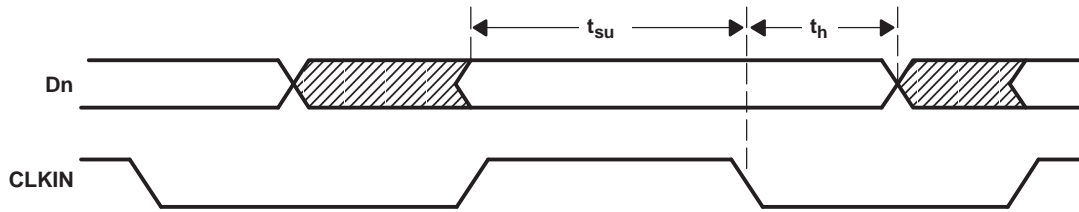


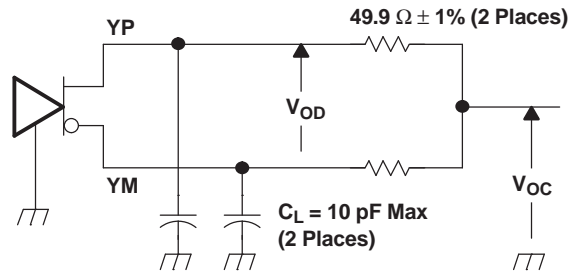
Figure 1. Typical Load and Shift Sequences



A. All input timing is defined at 1.4 V on an input signal with a 10%-to-90% rise or fall time of less than 5 ns.

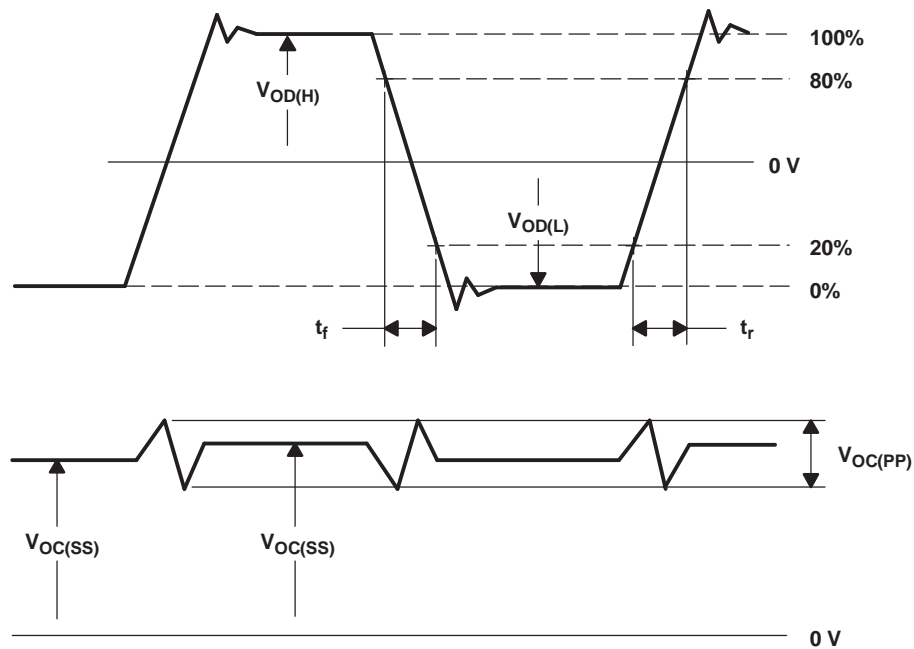
Figure 2. Setup and Hold Time Definition

PARAMETER MEASUREMENT INFORMATION (continued)



NOTE A: The lumped instrumentation capacitance for any single-ended voltage measurement is less than or equal to 10 pF. When making measurements at YP or YM, the complementary output is similarly loaded.

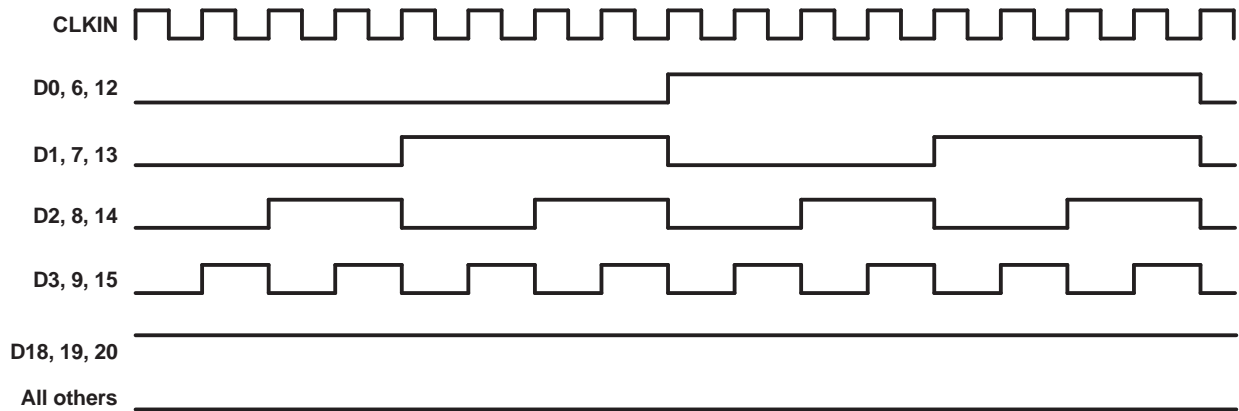
(a) SCHEMATIC



(b) WAVEFORMS

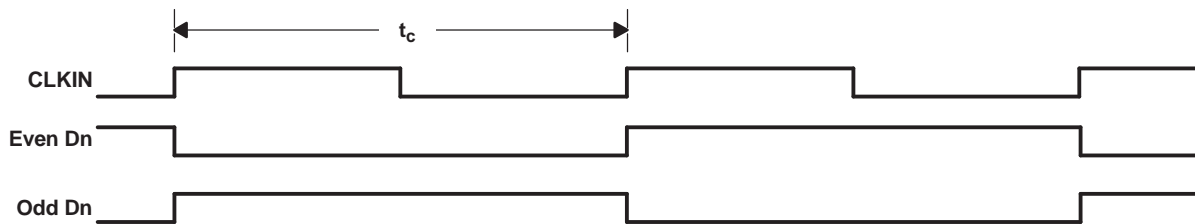
Figure 3. Test Load and Voltage Definitions for LVDS Outputs

**PARAMETER MEASUREMENT INFORMATION (continued)**



- A. The 16-grayscale test-pattern test device power consumption for a typical display pattern.
- B.  $V_{IH} = 2\text{ V}$  and  $V_{IL} = 0.8\text{ V}$

**Figure 4. 16-Grayscale Test-Pattern Waveforms**



- A. The worst-case test pattern produces nearly the maximum switching frequency for all of the LVDS outputs.
- B.  $V_{IH} = 2\text{ V}$  and  $V_{IL} = 0.8\text{ V}$

**Figure 5. Worst-Case Test-Pattern Waveforms**



PARAMETER MEASUREMENT INFORMATION (continued)

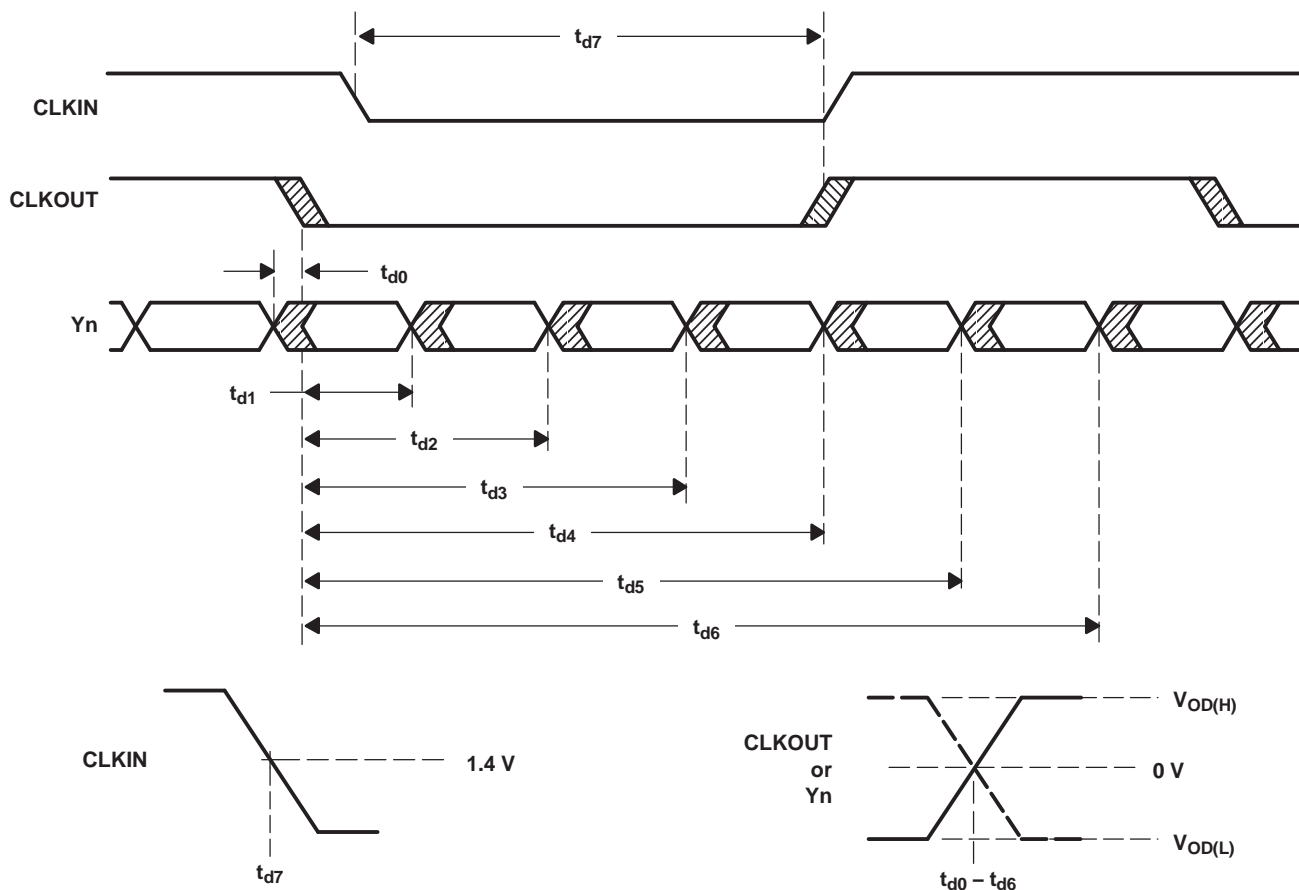


Figure 6. Timing Definitions

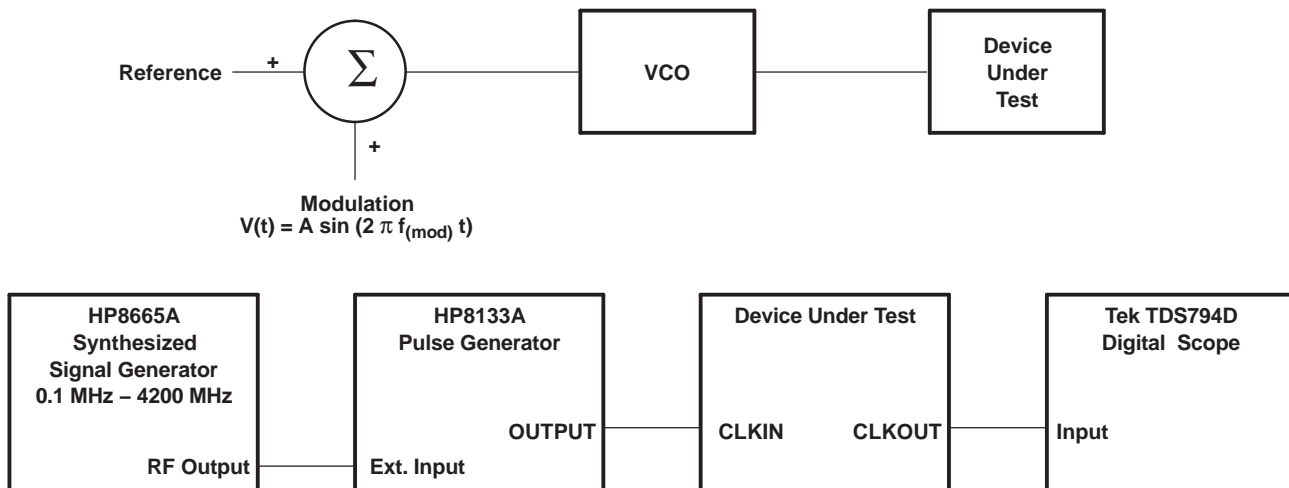


Figure 7. Clock Jitter Test Setup

TYPICAL CHARACTERISTICS

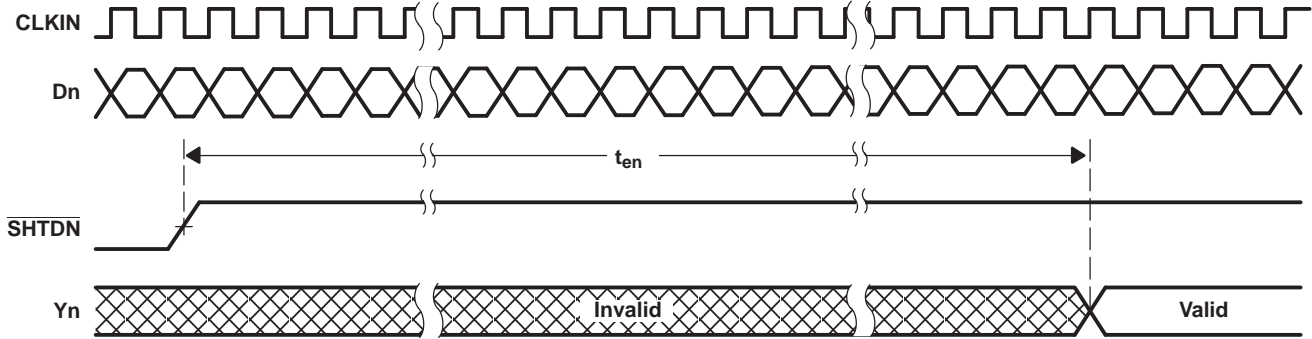


Figure 8. Enable Time Waveforms

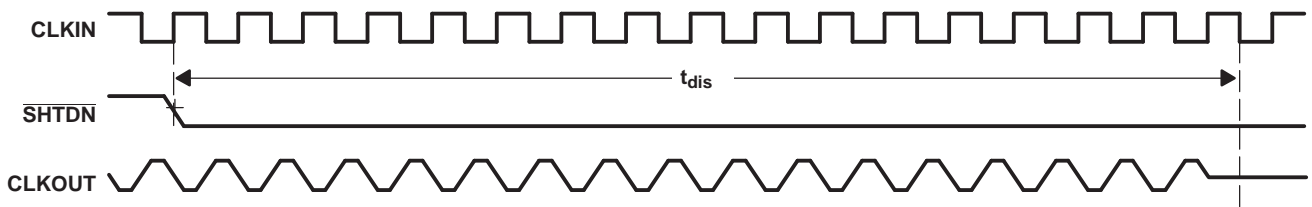


Figure 9. Disable Time Waveforms

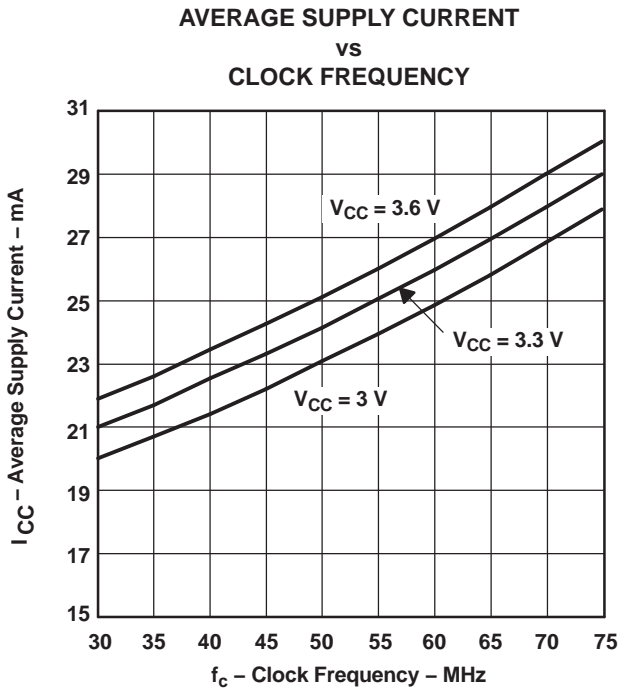


Figure 10. Grayscale Input Pattern

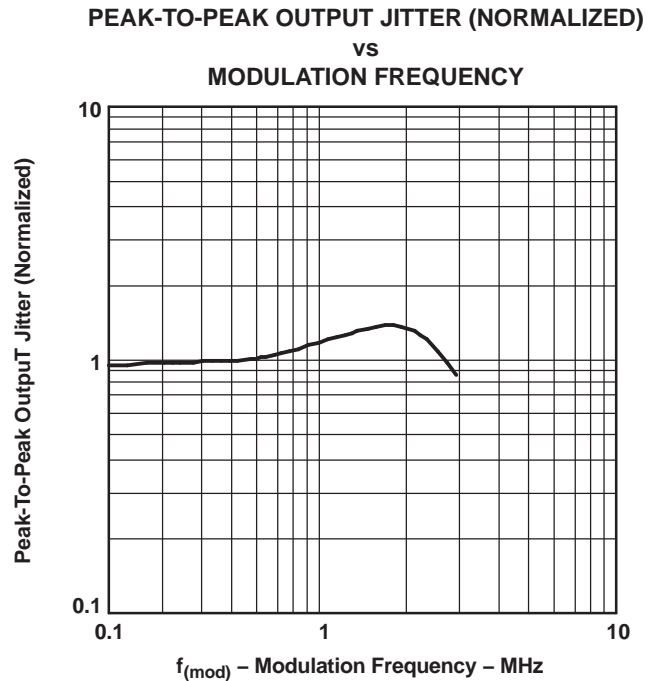
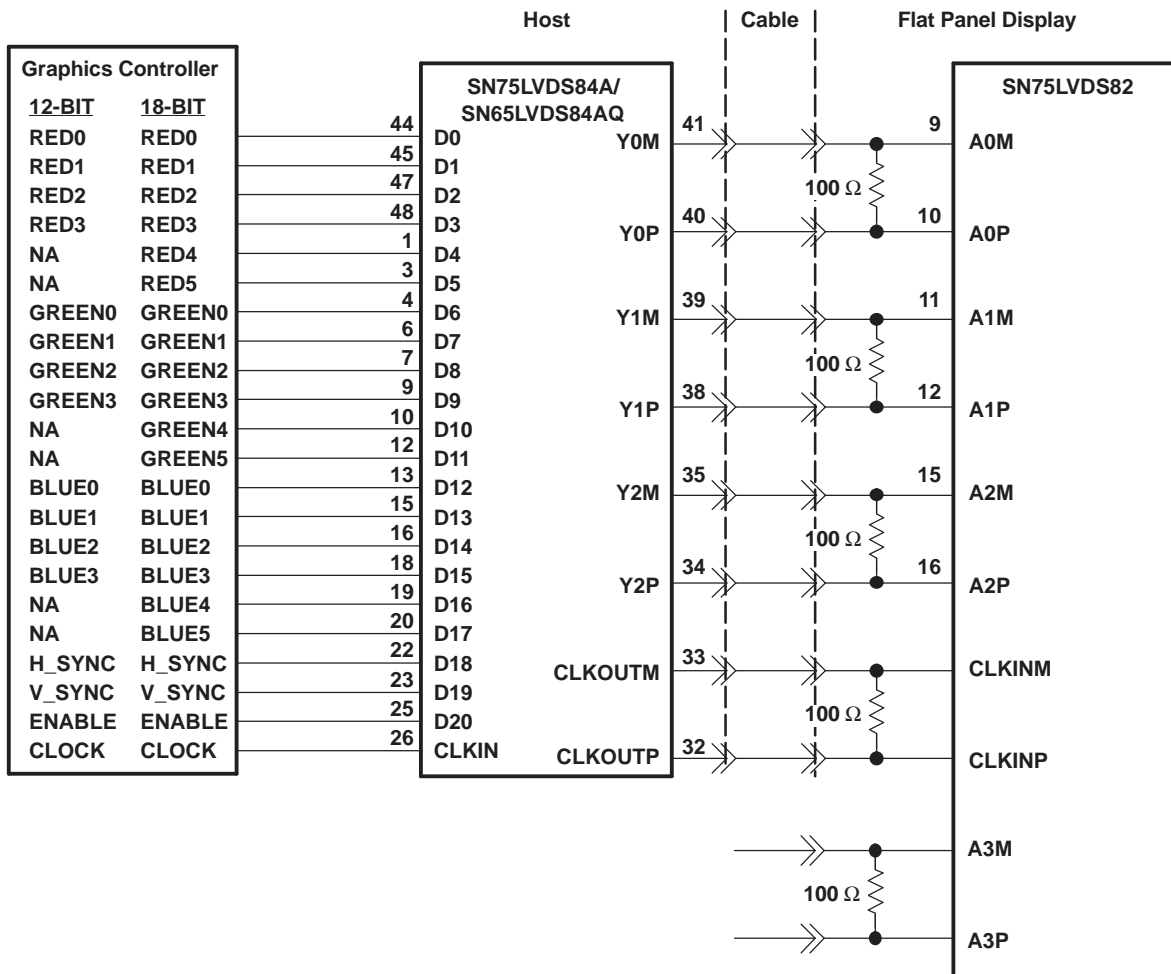


Figure 11. Output Period Jitter vs Modulation Frequency





- A. The four 100-Ω terminating resistors are recommended to be 0603 types.
- B. NA – not applicable, these unused inputs should be left open.

**Figure 13. 18-Bit Color Host to 24-Bit LCD Display Panel Application**

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN65LVDS84AQDGGRRQ1	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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DGG (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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